

# CD4026B, CD4033B Types

## CMOS Decade Counters/Dividers

High-Voltage Types (20-Volt Rating)

With Decoded 7-Segment Display Outputs and:

Display Enable – CD4026B

Ripple Blanking – CD4033B

■ CD4026B and CD4033B each consist of a 5-stage Johnson decade counter and an output decoder which converts the Johnson code to a 7-segment decoded output for driving one stage in a numerical display.

These devices are particularly advantageous in display applications where low power dissipation and/or low package count are important.

Inputs common to both types are CLOCK, RESET, & CLOCK INHIBIT; common outputs are CARRY OUT and the seven decoded outputs (a, b, c, d, e, f, g). Additional inputs and outputs for the CD4026B include DISPLAY ENABLE input and DISPLAY ENABLE and UNGATED "C-SEGMENT" outputs. Signals peculiar to the CD4033B are RIPPLE-BLANKING INPUT AND LAMP TEST INPUT and a RIPPLE-BLANKING OUTPUT.

A high RESET signal clears the decade counter to its zero count. The counter is advanced one count at the positive clock signal transition if the CLOCK INHIBIT signal is low. Counter advancement via the clock line is inhibited when the CLOCK INHIBIT signal is high. The CLOCK INHIBIT signal can be used as a negative-edge clock if the clock line is held high. Antilock gating is provided on the JOHNSON counter, thus assuring proper counting sequence. The CARRY-OUT ( $C_{out}$ ) signal completes one cycle every ten CLOCK INPUT cycles and is used to clock the succeeding decade directly in a multi-decade counting chain. The seven decoded outputs (a, b, c, d, e, f, g) illuminate the proper segments in a seven

### Features:

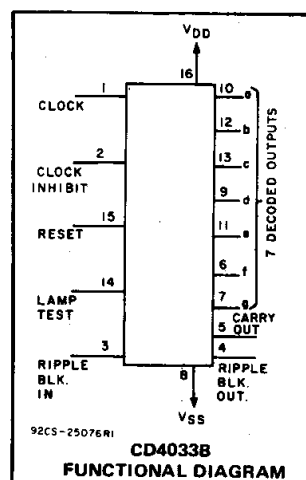
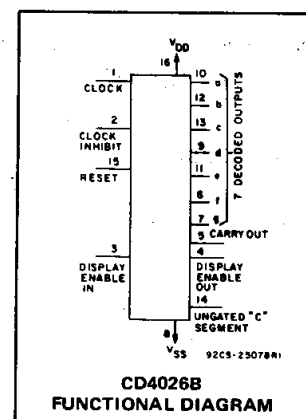
- Counter and 7-segment decoding in one package
- Easily interfaced with 7-segment display types
- Fully static counter operation: DC to 6 MHz (typ.) at  $V_{DD}=10\text{ V}$
- Ideal for low-power displays
- Display enable output (CD4026B)
- "Ripple blanking" and lamp test (CD4033B)
- 100% tested for quiescent current at 20 V
- Standardized, symmetrical output characteristics

- 5-V, 10-V, and 15-V parametric ratings
- Schmitt-triggered clock inputs
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

### Applications

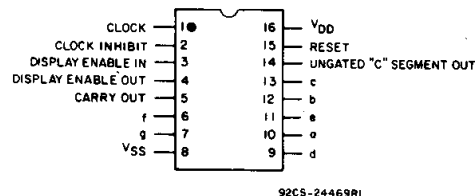
- Decade counting 7-segment decimal display
- Frequency division 7-segment decimal displays
- Clocks, watches, timers (e.g.  $\div 60$ ,  $\div 60$ ,  $\div 12$  counter/display)
- Counter/display driver for meter applications

segment display device used for representing the decimal numbers 0 to 9. The 7-segment outputs go high on selection in the CD4033B; in the CD4026B these outputs go high only when the DISPLAY ENABLE IN is high.



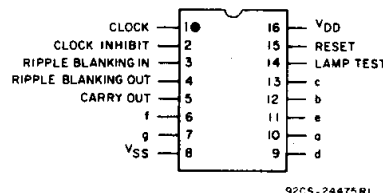
### TERMINAL DIAGRAMS

#### Top View



CD4026B

#### Top View



CD4033B

### MAXIMUM RATINGS, Absolute-Maximum Values:

#### DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ )

Voltages referenced to  $V_{SS}$  Terminal) ..... -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS ..... -0.5V to  $V_{DD} + 0.5\text{V}$

DC INPUT CURRENT, ANY ONE INPUT .....  $\pm 10\text{mA}$

#### POWER DISSIPATION PER PACKAGE ( $P_D$ ):

For  $T_A = -55^\circ\text{C}$  to  $+100^\circ\text{C}$  ..... 500mW

For  $T_A = +100^\circ\text{C}$  to  $+125^\circ\text{C}$  ..... Derate Linearly at 12mW/ $^\circ\text{C}$  to 200mW

#### DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR  $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$  ..... 100mW

OPERATING-TEMPERATURE RANGE ( $T_A$ ) .....  $-55^\circ\text{C}$  to  $+125^\circ\text{C}$

STORAGE TEMPERATURE RANGE ( $T_{stg}$ ) .....  $-65^\circ\text{C}$  to  $+150^\circ\text{C}$

#### LEAD TEMPERATURE (DURING SOLDERING):

At distance 1/16  $\pm$  1/32 inch (1.59  $\pm$  0.79mm) from case for 10s max .....  $+265^\circ\text{C}$

## CD4026B, CD4033B Types

### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC                                                             | V <sub>DD</sub><br>(V) | LIMITS           |                 | UNITS |
|----------------------------------------------------------------------------|------------------------|------------------|-----------------|-------|
|                                                                            |                        | MIN.             | MAX.            |       |
| Supply-Voltage Range (For T <sub>A</sub> = Full Package Temperature Range) |                        | 3                | 18              | V     |
| Clock Input Frequency, f <sub>CL</sub>                                     | 5<br>10<br>15          | —<br>—<br>—      | 2.5<br>5.5<br>8 | MHz   |
| Clock Pulse Width, t <sub>WCL</sub>                                        | 5<br>10<br>15          | 220<br>100<br>80 | —<br>—<br>—     | ns    |
| Clock Rise and Fall Time, t <sub>CL</sub> , t <sub>FCL</sub>               | 5<br>10<br>15          | —<br>—<br>—      | Unlimited       |       |
| Clock Inhibit Set Up Time, t <sub>SU</sub>                                 | 5<br>10<br>15          | 200<br>50<br>30  | —<br>—<br>—     |       |
| Reset Pulse Width, t <sub>W</sub>                                          | 5<br>10<br>15          | 200<br>100<br>50 | —<br>—<br>—     |       |
| Reset Removal Time                                                         | 5<br>10<br>15          | 30<br>15<br>10   | —<br>—<br>—     |       |

### CD4026B

When the DISPLAY ENABLE IN is low the seven decoded outputs are forced low regardless of the state of the counter. Activation of the display only when required results in significant power savings. This system also facilitates implementation of display-character multiplexing.

The CARRY OUT and UNGATED "C-SEGMENT" signals are not gated by the DISPLAY ENABLE and therefore are available continuously. This feature is a requirement in implementation of certain divider functions such as divide-by-60 and divide-by-12.

### CD4033B

The CD4033B has provisions for automatic blanking of the non-significant zeros in a multi-digit decimal number which results in an easily readable display consistent with normal writing practice. For example, the number 0050.0700 in an eight digit display would be displayed as 50.07. Zero suppression on the integer side is obtained by connecting the RBI terminal of the CD4033B associated with the most significant digit in the display to a low-level voltage and connecting the RBO terminal of that stage to the RBI terminal of the CD4033B in the next-lower significant position in the display. This procedure is continued for each succeeding CD4033B on the integer side of the display.

On the fraction side of the display the RBI of the CD4033B associated with the least significant bit is connected to a low-level voltage and the RBO of that CD4033B is connected to the RBI terminal of the CD4033B in the next more-significant-bit position. Again, this procedure is continued for all CD4033B's on the fraction side of the display.

In a purely fractional number the zero immediately preceding the decimal point can be displayed by connecting the RBI of that stage to a high level voltage (instead of to the RBO of the next more-significant-stage). For example: optional zero → 0.7346. Likewise, the zero in a number such as 763.0 can be displayed by connecting the RBI of the CD4033B associated with it to a high-level voltage.

Ripple blanking of non-significant zeros provides an appreciable savings in display power.

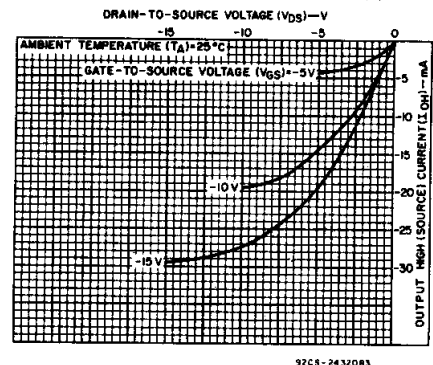
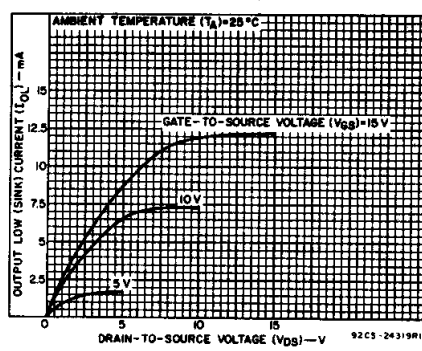
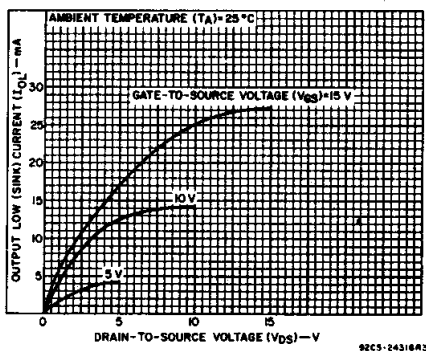
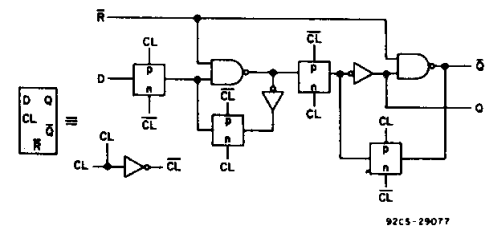
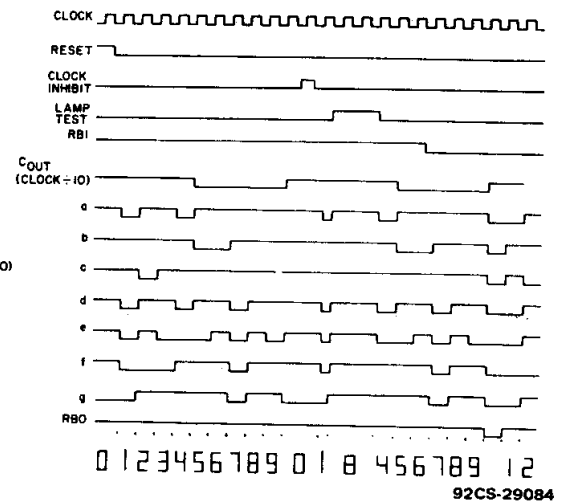
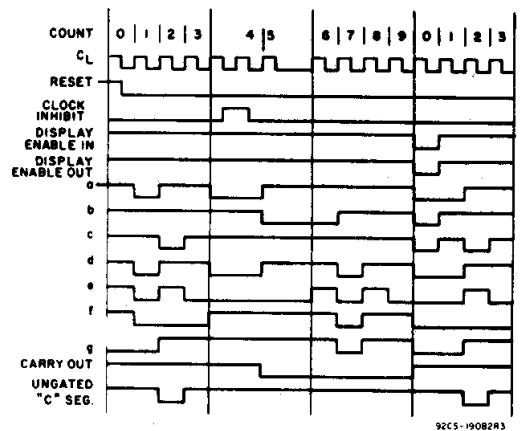
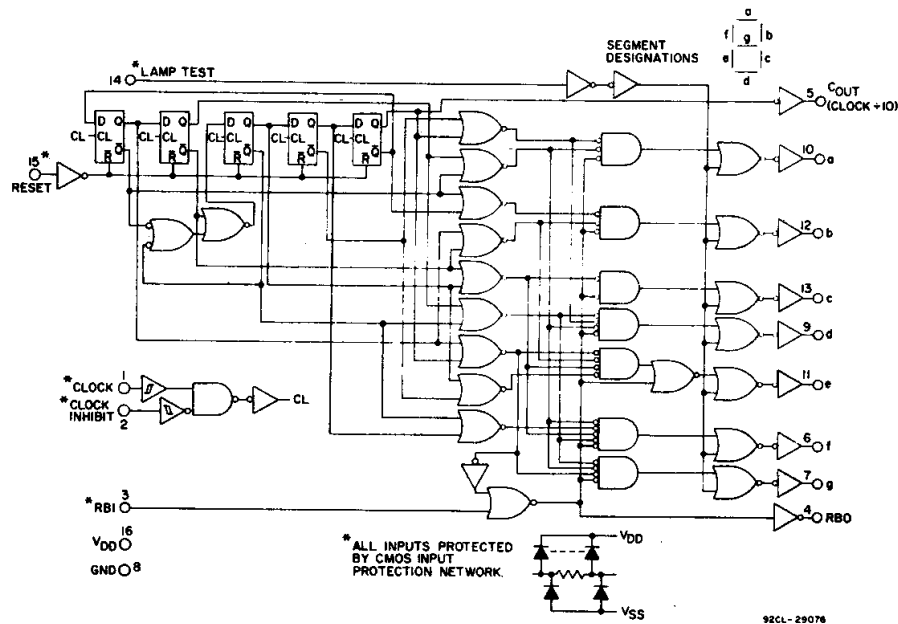
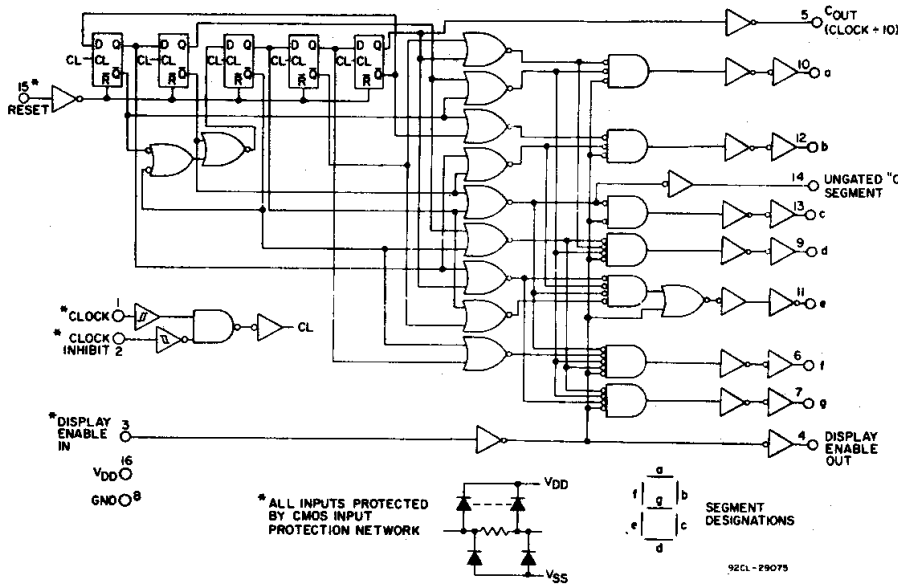
The CD4033B has a LAMP TEST input which, when connected to a high-level voltage, overrides normal decoder operation and enables a check to be made on possible display malfunctions by putting the seven outputs in the high state.

The CD4026B- and CD4033B-series types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

### STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER-<br>ISTIC                                         | CONDITIONS            |                        |                        | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |       |                   |      | UNITS |
|-------------------------------------------------------------|-----------------------|------------------------|------------------------|---------------------------------------|-------|-------|-------|-------|-------------------|------|-------|
|                                                             | V <sub>O</sub><br>(V) | V <sub>IN</sub><br>(V) | V <sub>DD</sub><br>(V) |                                       |       |       |       | +25   |                   |      |       |
|                                                             |                       |                        |                        | −55                                   | −40   | +85   | +125  | Min.  | Typ.              | Max. |       |
| Quiescent Device<br>Current,<br>I <sub>DD</sub> Max.        | —                     | 0,5                    | 5                      | 5                                     | 5     | 150   | 150   | —     | 0.04              | 5    | μA    |
|                                                             | —                     | 0,10                   | 10                     | 10                                    | 10    | 300   | 300   | —     | 0.04              | 10   |       |
|                                                             | —                     | 0,15                   | 15                     | 20                                    | 20    | 600   | 600   | —     | 0.04              | 20   |       |
|                                                             | —                     | 0,20                   | 20                     | 100                                   | 100   | 3000  | 3000  | —     | 0.08              | 100  |       |
| Output Low<br>(Sink) Current<br>I <sub>OL</sub> Min.        | 0.4                   | 0,5                    | 5                      | 0.64                                  | 0.61  | 0.42  | 0.36  | 0.51  | 1                 | —    | mA    |
|                                                             | 0.5                   | 0,10                   | 10                     | 1.6                                   | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               | —    |       |
|                                                             | 1.5                   | 0,15                   | 15                     | 4.2                                   | 4     | 2.8   | 2.4   | 3.4   | 6.8               | —    |       |
| Output High<br>(Source)<br>Current,<br>I <sub>OH</sub> Min. | 4.6                   | 0,5                    | 5                      | −0.64                                 | −0.61 | −0.42 | −0.36 | −0.51 | −1                | —    | mA    |
|                                                             | 2.5                   | 0,5                    | 5                      | −2                                    | −1.8  | −1.3  | −1.15 | −1.6  | −3.2              | —    |       |
|                                                             | 9.5                   | 0,10                   | 10                     | −1.6                                  | −1.5  | −1.1  | −0.9  | −1.3  | −2.6              | —    |       |
|                                                             | 13.5                  | 0,15                   | 15                     | −4.2                                  | −4    | −2.8  | −2.4  | −3.4  | −6.8              | —    |       |
| Output Voltage:<br>Low-Level,<br>V <sub>OL</sub> Max.       | —                     | 0,5                    | 5                      | 0.05                                  |       |       |       | —     | 0                 | 0.05 | V     |
|                                                             | —                     | 0,10                   | 10                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
|                                                             | —                     | 0,15                   | 15                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
| Output Voltage:<br>High-Level,<br>V <sub>OH</sub> Min.      | —                     | 0,5                    | 5                      | 4.95                                  |       |       |       | 4.95  | 5                 | —    | V     |
|                                                             | —                     | 0,10                   | 10                     | 9.95                                  |       |       |       | 9.95  | 10                | —    |       |
|                                                             | —                     | 0,15                   | 15                     | 14.95                                 |       |       |       | 14.95 | 15                | —    |       |
| Input Low<br>Voltage,<br>V <sub>IL</sub> Max.               | 0.5, 4,5              | —                      | 5                      | 1.5                                   |       |       |       | —     | —                 | 1.5  | V     |
|                                                             | 1, 9                  | —                      | 10                     | 3                                     |       |       |       | —     | —                 | 3    |       |
|                                                             | 1.5,13.5              | —                      | 15                     | 4                                     |       |       |       | —     | —                 | 4    |       |
| Input High<br>Voltage,<br>V <sub>IH</sub> Min.              | 0.5, 4,5              | —                      | 5                      | 3.5                                   |       |       |       | 3.5   | —                 | —    | V     |
|                                                             | 1, 9                  | —                      | 10                     | 7                                     |       |       |       | 7     | —                 | —    |       |
|                                                             | 1.5,13.5              | —                      | 15                     | 11                                    |       |       |       | 11    | —                 | —    |       |
| Input Current<br>I <sub>IN</sub> Max.                       | —                     | 0,18                   | 18                     | ±0.1                                  | ±0.1  | ±1    | ±1    | —     | ±10 <sup>−5</sup> | ±0.1 | μA    |

# CD4026B, CD4033B Types



# CD4026B, CD4033B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at  $T_A = 25^\circ\text{C}$ , Input  $t_r, t_f = 20\text{ ns}$ ,  
 $C_L = 50\text{ pF}$ ,  $R_L = 200\text{ k}\Omega$

| CHARACTERISTIC                                                   | TEST<br>CONDITIONS | LIMITS     |           |      |      | UNITS |
|------------------------------------------------------------------|--------------------|------------|-----------|------|------|-------|
|                                                                  |                    | VDD<br>(V) | Min.      | Typ. | Max. |       |
| CLOCKED OPERATION                                                |                    |            |           |      |      |       |
| Propagation Delay Time;<br>Carry-Out Line<br>$t_{PLH}, t_{PHL}$  |                    | 5          | —         | 250  | 500  | ns    |
|                                                                  |                    | 10         | —         | 100  | 200  |       |
|                                                                  |                    | 15         | —         | 75   | 150  |       |
| Decode Outlines                                                  |                    | 5          | —         | 350  | 700  | ns    |
|                                                                  |                    | 10         | —         | 125  | 250  |       |
|                                                                  |                    | 15         | —         | 90   | 180  |       |
| Transition Time;<br>Carry-Out Line<br>$t_{THL}, t_{TLH}$         |                    | 5          | —         | 100  | 200  | ns    |
|                                                                  |                    | 10         | —         | 50   | 100  |       |
|                                                                  |                    | 15         | —         | 25   | 50   |       |
| Maximum Clock Input Frequency, $f_{CL}^{\Delta}$                 |                    | 5          | 2.5       | 5    | —    | MHz   |
|                                                                  |                    | 10         | 5.5       | 11   | —    |       |
|                                                                  |                    | 15         | 8         | 16   | —    |       |
| Min. Clock Pulse Width, $t_W$                                    |                    | 5          | —         | 110  | 220  | ns    |
|                                                                  |                    | 10         | —         | 50   | 100  |       |
|                                                                  |                    | 15         | —         | 40   | 80   |       |
| Clock and Clock Inhibit Rise or Fall Time;<br>$t_{rCL}, t_{fCL}$ |                    | 5          | Unlimited |      |      | ns    |
|                                                                  |                    | 10         |           |      |      |       |
|                                                                  |                    | 15         |           |      |      |       |
| Average Input Capacitance, $C_{IN}$                              | Any Input          | —          | 5         | 7    | pF   |       |
| RESET OPERATION                                                  |                    |            |           |      |      |       |
| Propagation Delay Time;<br>To Carry-Out Line, $t_{PLH}$          |                    | 5          | —         | 275  | 550  | ns    |
|                                                                  |                    | 10         | —         | 120  | 240  |       |
|                                                                  |                    | 15         | —         | 80   | 160  |       |
| To Decode Out Lines, $t_{PHL}, t_{PLH}$                          |                    | 5          | —         | 300  | 600  | ns    |
|                                                                  |                    | 10         | —         | 125  | 250  |       |
|                                                                  |                    | 15         | —         | 90   | 180  |       |
| Min. Reset Pulse Width, $t_W$                                    |                    | 5          | —         | 100  | 120  | ns    |
|                                                                  |                    | 10         | —         | 50   | 100  |       |
|                                                                  |                    | 15         | —         | 25   | 50   |       |
| Min. Reset Removal Time                                          |                    | 5          | —         | 0    | 30   | ns    |
|                                                                  |                    | 10         | —         | 0    | 15   |       |
|                                                                  |                    | 15         | —         | 0    | 10   |       |

$\Delta$  Measured with respect to carry-out line.

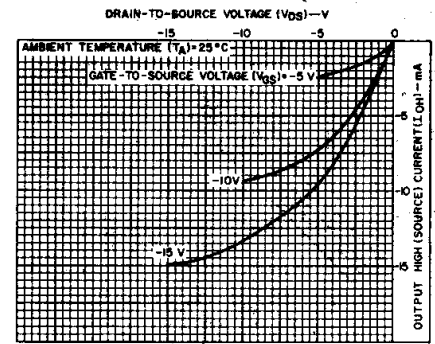


Fig. 9 — Minimum p-channel output high (source) current characteristics.

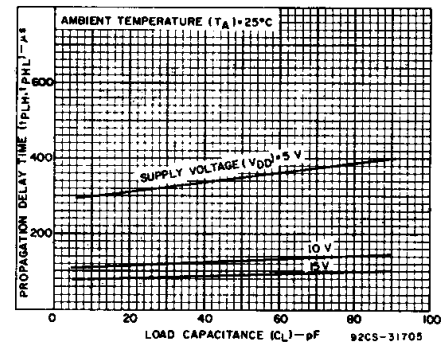


Fig. 10 — Typical propagation delay time as a function of load capacitance for decoded outputs.

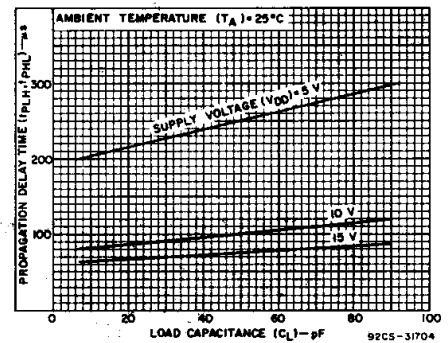


Fig. 11 — Typical propagation delay time as a function of load capacitance for carry-out outputs.

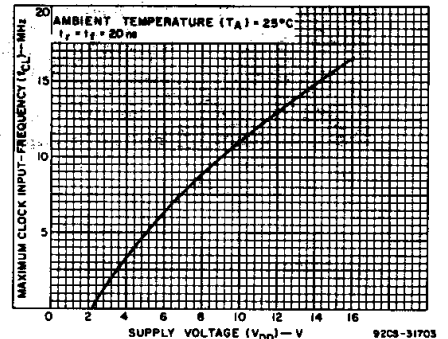


Fig. 12 — Typical maximum clock input frequency as a function of supply voltage.

## CD4026B, CD4033B Types

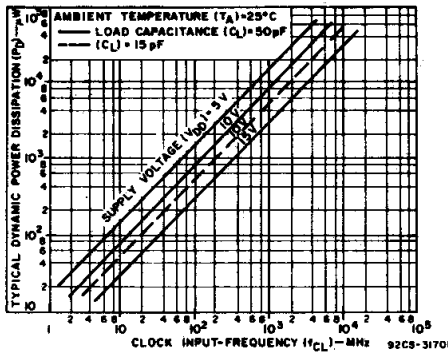


Fig. 13 - Typical power dissipation as a function of clock input frequency.

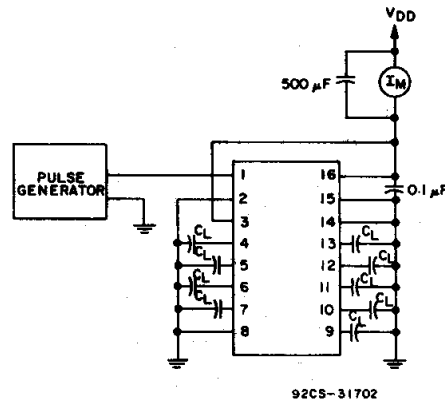


Fig. 14 - Dynamic power dissipation test circuit for CD4033B.

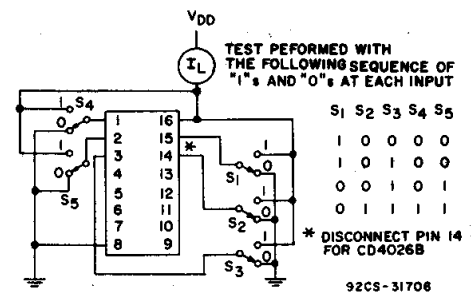


Fig. 15 - Quiescent device current.

## INTERFACING THE CD4026B AND CD4033B WITH COMMERCIALY AVAILABLE LIGHT EMITTING DIODE DISPLAYS

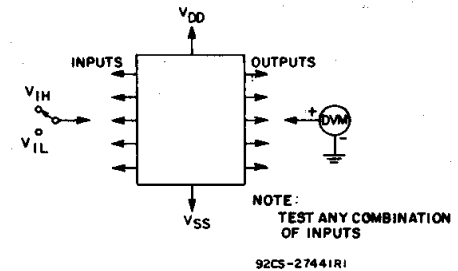
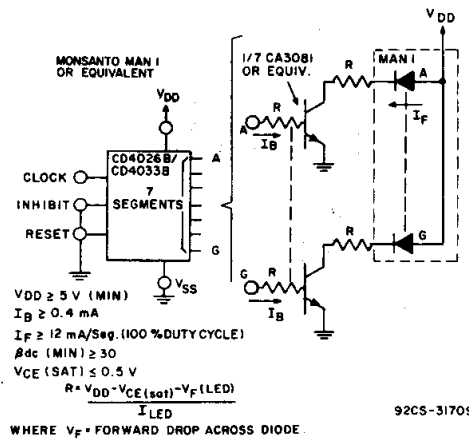
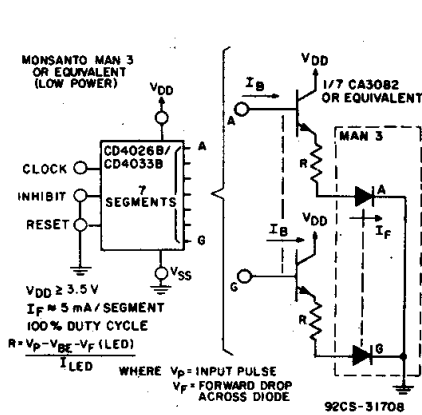


Fig. 16 - Input voltage.

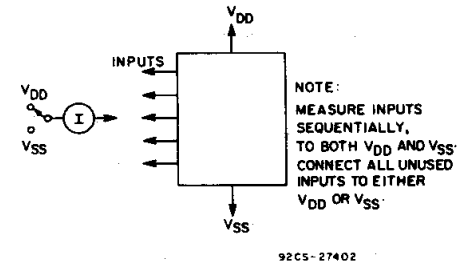
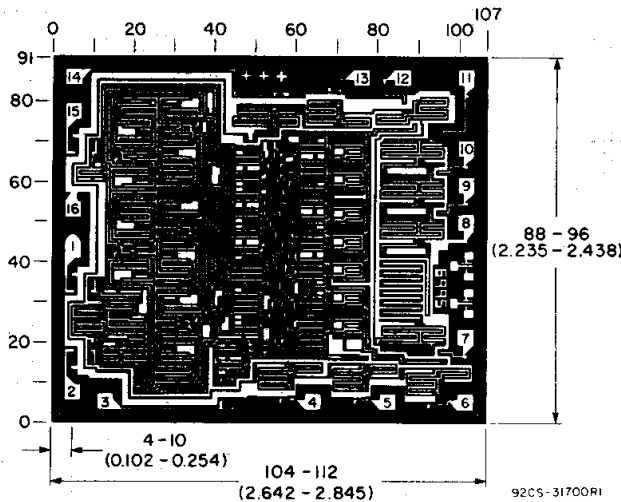
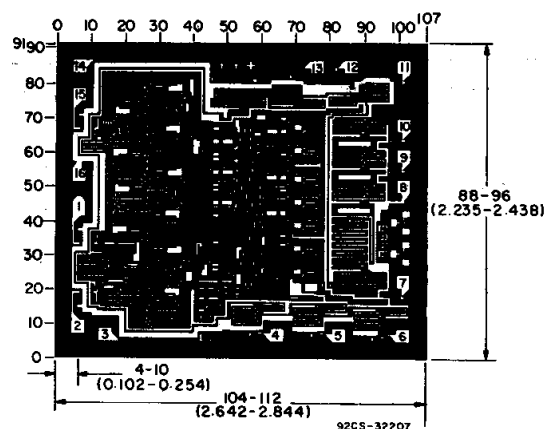


Fig. 17 - Input current.



Chip dimensions and pad layout for CD4026B

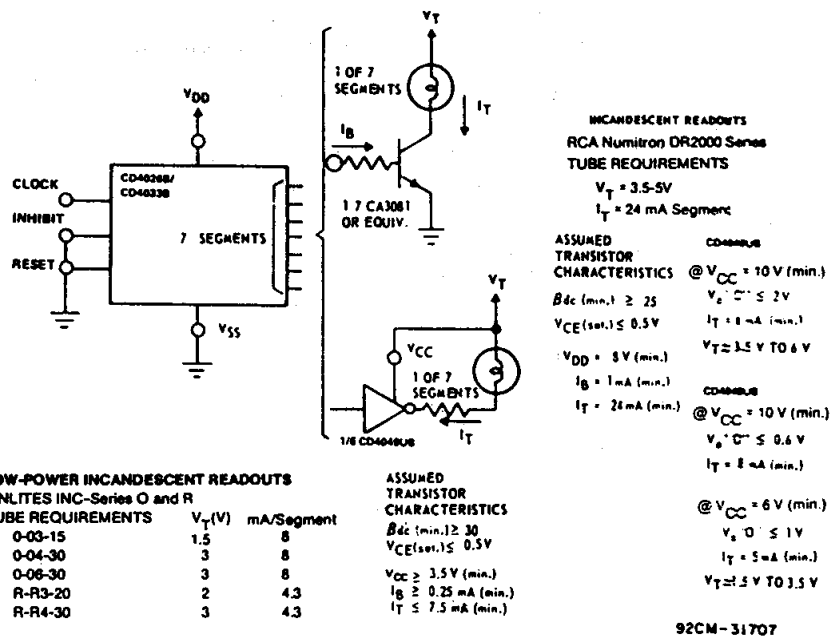
Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).



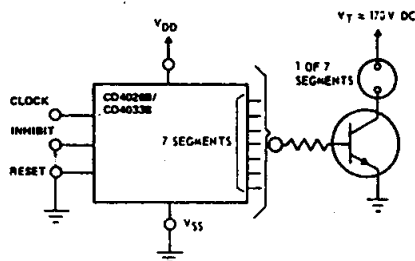
Chip dimensions and pad layout for CD4033B

## CD4026B, CD4033B Types

### INTERFACING THE CD4026B AND CD4033B WITH COMMERCIALLY AVAILABLE 7-SEGMENT DISPLAY DEVICES\*



\* The interfacing buffers shown, while a necessity with the CD4026A and CD4033A, are not required when using the "B" devices; the "B" outputs ( $\approx 10$  times the "A" outputs) can drive most display devices directly especially at voltages above 10 V.



#### NEON READOUT (NIXIE TUBE\*)

1. Alco Electronics - MG19
2. Burroughs - B5971, B7971, B8971

| TUBE REQUIREMENTS      | $V_T$ (Vdc) | mA Segment |
|------------------------|-------------|------------|
| Alco MG19              | 180         | 0.5        |
| Burroughs B5971        | 170         | 3          |
| Burroughs B7971, B8971 | 170         | 6          |

\* (Trademark) Burroughs Corp.

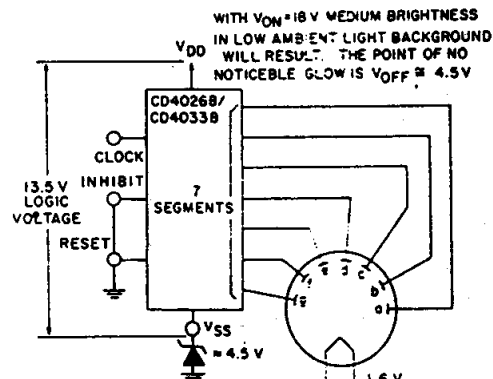
#### TRANSISTOR CHARACTERISTICS

Leakage with transistor cutoff - 0.05 mA

$V_{(BR)CER} > V_T$

$\beta_{dc} (\min.) \geq 30$

92CS-31710



#### LOW VOLTAGE VACUUM FLUORESCENT READOUTS

1. Tung-Sol DIGIVAC S/G; Type DT1704A or DT1705C
2. Nippon Electric (NEC); Type DG12E or LD51S

TUBE REQUIREMENTS: 100 to 300  $\mu A$ /segment at tube voltages of 12 V to 25 V depending on required brightness Filament requirement 45 mA at 1.6 V, ac or dc.

\* (Trademark) Wagner Electric Co.

92CS-31711

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| CD4026BE         | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4026BEE4       | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4026BNSR       | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4026BNSRE4     | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4026BNSRG4     | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4026BPW        | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4026BPWE4      | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4026BPWG4      | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4026BPWR       | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4026BPWRE4     | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4026BPWRG4     | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4033BE         | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4033BEE4       | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4033BPW        | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4033BPWE4      | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4033BPWG4      | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

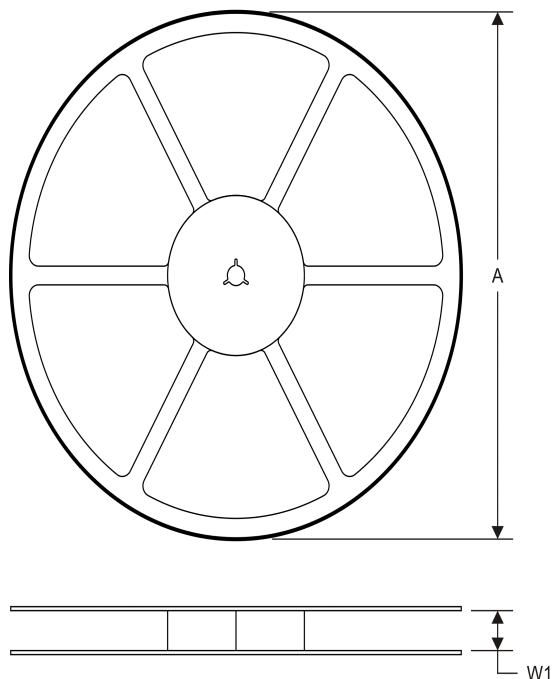
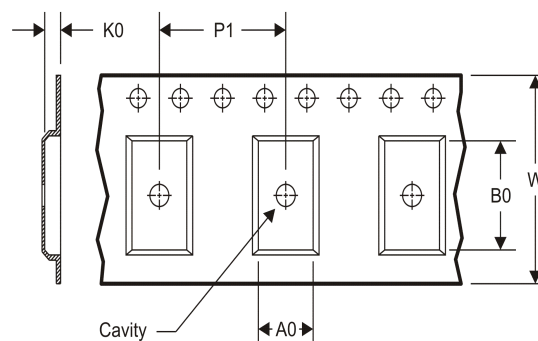
---

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

**TAPE DIMENSIONS**


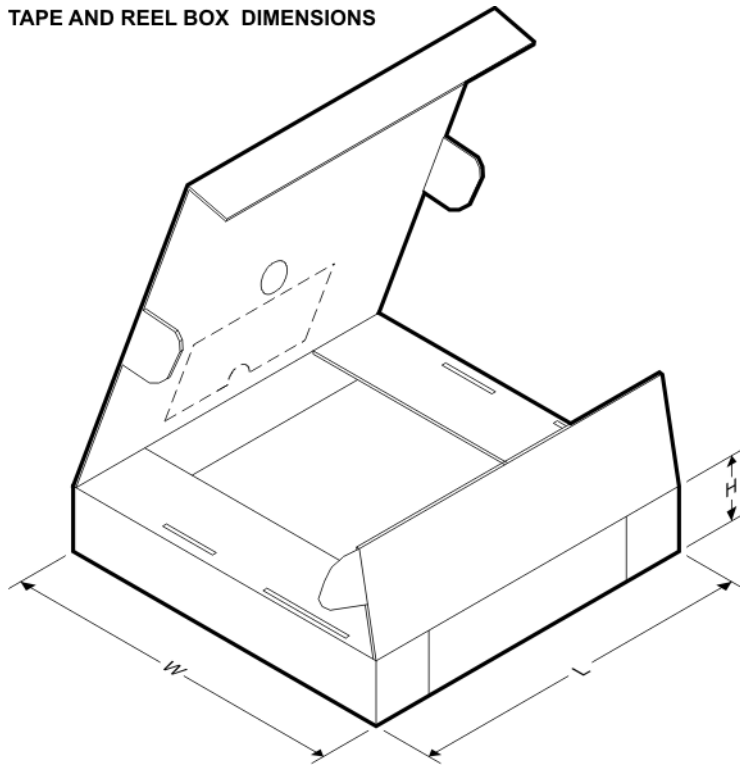
|    |                                                           |
|----|-----------------------------------------------------------|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD4026BNSR | SO           | NS              | 16   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |
| CD4026BPWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



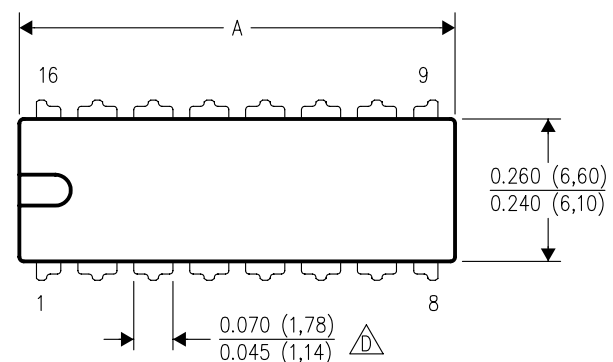
\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD4026BNSR | SO           | NS              | 16   | 2000 | 367.0       | 367.0      | 38.0        |
| CD4026BPWR | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |

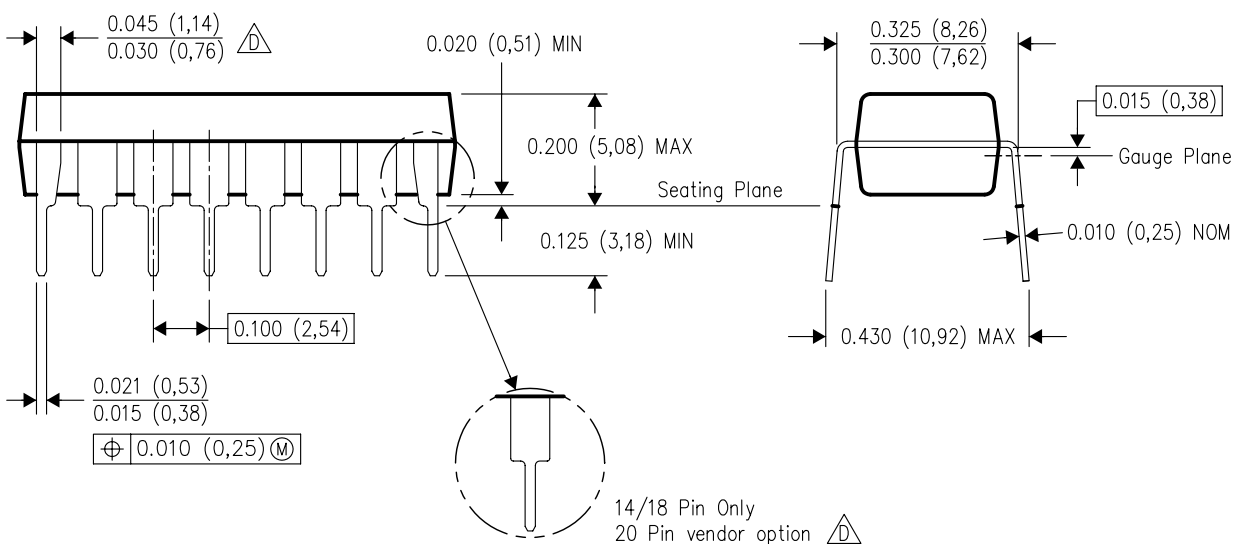
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



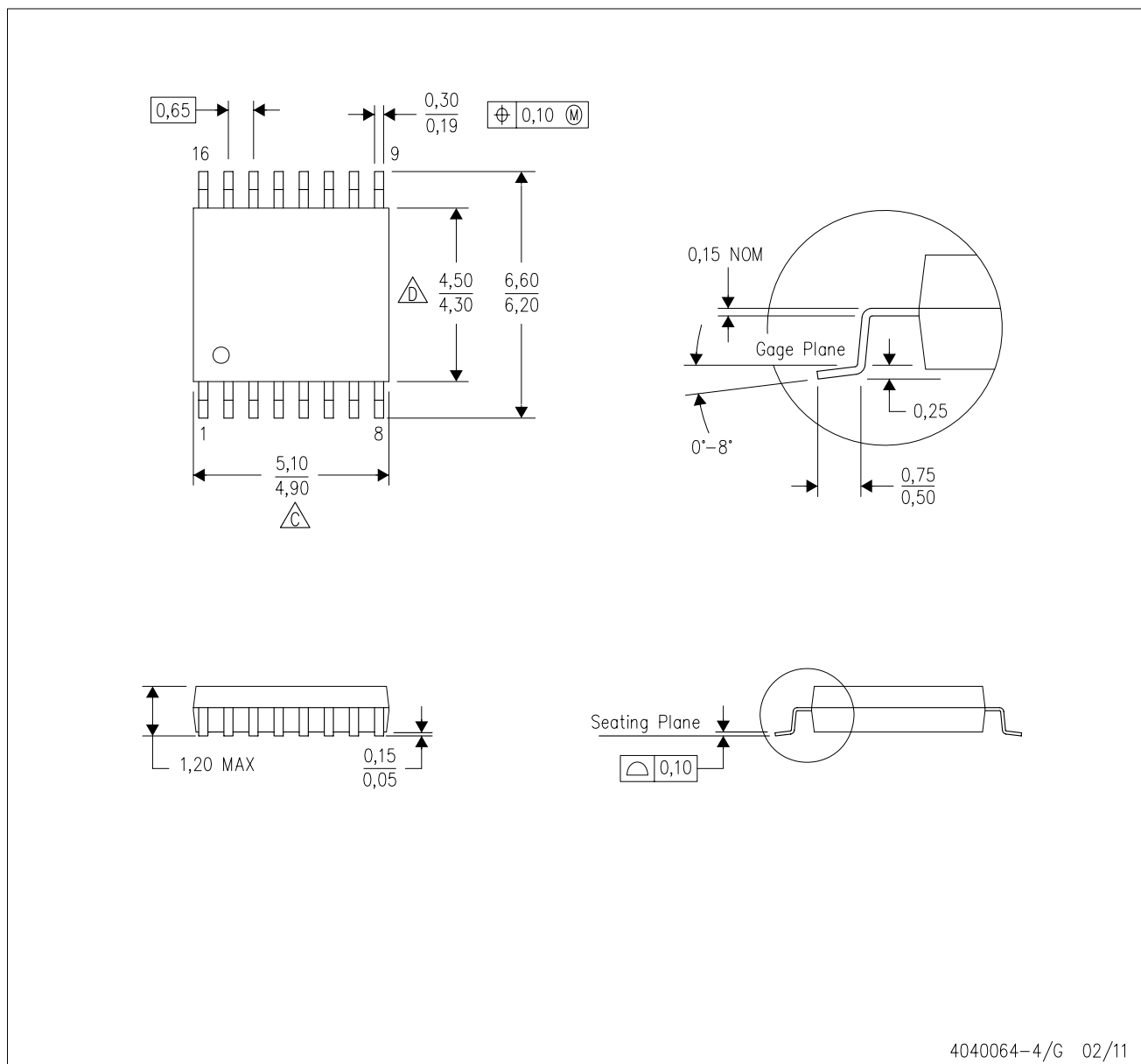
4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

PW (R-PDSO-G16)

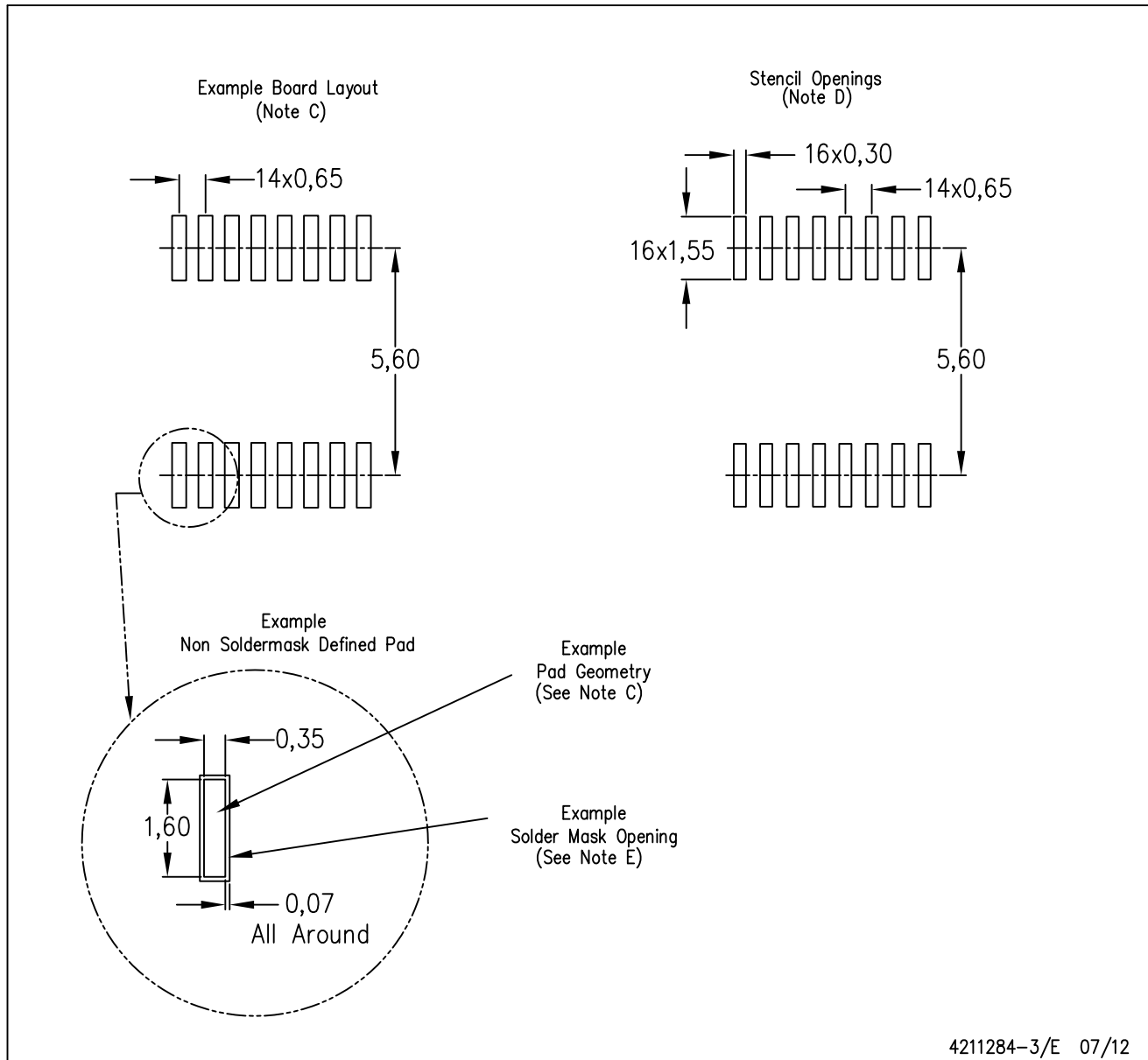
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



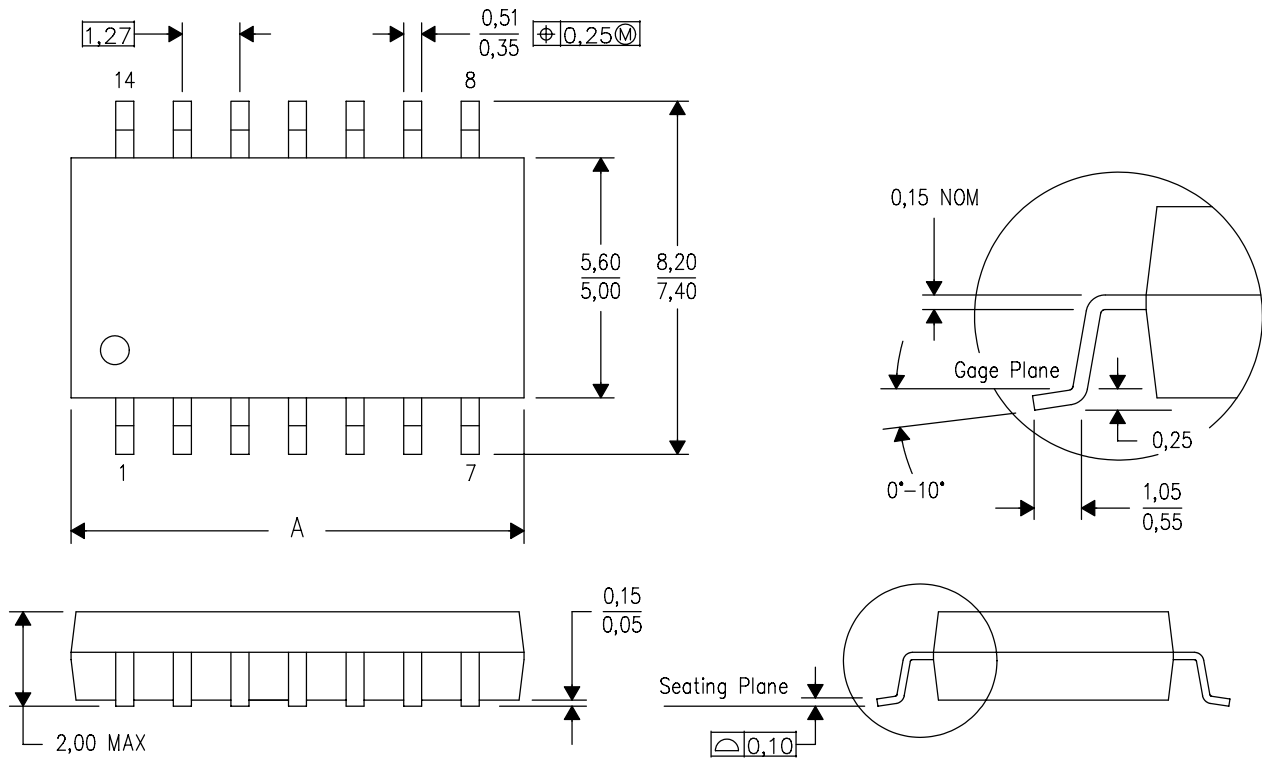
- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



| DIM \ PINS ** | 14    | 16    | 20    | 24    |
|---------------|-------|-------|-------|-------|
| A MAX         | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN         | 9,90  | 9,90  | 12,30 | 14,70 |

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46C and to discontinue any product or service per JESD48B. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components which meet ISO/TS16949 requirements, mainly for automotive use. Components which have not been so designated are neither designed nor intended for automotive use; and TI will not be responsible for any failure of such components to meet such requirements.

### Products

|                        |                                                                                      |
|------------------------|--------------------------------------------------------------------------------------|
| Audio                  | <a href="http://www.ti.com/audio">www.ti.com/audio</a>                               |
| Amplifiers             | <a href="http://amplifier.ti.com">amplifier.ti.com</a>                               |
| Data Converters        | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>                       |
| DLP® Products          | <a href="http://www.dlp.com">www.dlp.com</a>                                         |
| DSP                    | <a href="http://dsp.ti.com">dsp.ti.com</a>                                           |
| Clocks and Timers      | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>                             |
| Interface              | <a href="http://interface.ti.com">interface.ti.com</a>                               |
| Logic                  | <a href="http://logic.ti.com">logic.ti.com</a>                                       |
| Power Mgmt             | <a href="http://power.ti.com">power.ti.com</a>                                       |
| Microcontrollers       | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a>                   |
| RFID                   | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
| OMAP Mobile Processors | <a href="http://www.ti.com/omap">www.ti.com/omap</a>                                 |
| Wireless Connectivity  | <a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a> |

### Applications

|                               |                                                                                          |
|-------------------------------|------------------------------------------------------------------------------------------|
| Automotive and Transportation | <a href="http://www.ti.com/automotive">www.ti.com/automotive</a>                         |
| Communications and Telecom    | <a href="http://www.ti.com/communications">www.ti.com/communications</a>                 |
| Computers and Peripherals     | <a href="http://www.ti.com/computers">www.ti.com/computers</a>                           |
| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
| Industrial                    | <a href="http://www.ti.com/industrial">www.ti.com/industrial</a>                         |
| Medical                       | <a href="http://www.ti.com/medical">www.ti.com/medical</a>                               |
| Security                      | <a href="http://www.ti.com/security">www.ti.com/security</a>                             |
| Space, Avionics and Defense   | <a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a> |
| Video and Imaging             | <a href="http://www.ti.com/video">www.ti.com/video</a>                                   |

**TI E2E Community** [e2e.ti.com](http://e2e.ti.com)



**Стандарт  
Электрон  
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

**Наши контакты:**

**Телефон:** +7 812 627 14 35

**Электронная почта:** [sales@st-electron.ru](mailto:sales@st-electron.ru)

**Адрес:** 198099, Санкт-Петербург,  
Промышленная ул, дом № 19, литера Н,  
помещение 100-Н Офис 331